

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image



















High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.00 mm, Number of poles: 17, 180°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1841310000</u>
Туре	SL-SMT 5.00HC/17/180G 3.2SN BK BX
GTIN (EAN)	4032248352210
Qty.	20 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Вох

Creation date October 30, 2021 12:13:06 PM CEST



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Technical data

Dimensions and weights

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Width	88.2 mm
Width (inches)	3.472 inch	Net weight	7.65 g

System specifications

Product family	OMNIMATE Signal - series	Type of connection	
	BL/SL 5.00		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	17	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	+0.1 / -0.2 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0,03 mm
Solder eyelet hole diameter (D)	1.5 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm
L1 in mm	80 mm	L1 in inches	3.15 inch
Number of rows	1	Pin series quantity	1
Protection degree	IP20	Volume resistance	≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	7 N
Pulling force/pole, max.	5.5 N		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		



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Technical data

Rated data acc. to CSA

Institute (CSA)	^	Certificate No. (CSA)	
	CD.		
	OF.		
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Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	15 A	Rated current (Use group D / CSA)	15 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Rated data acc. to UL 1059			
Institute (UR)		Certificate No. (UR)	
oute (e.i,	<i>2</i> 17.	ostanicato itoli (ci.i)	
			E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Box	VPE length	208 mm
VPE width	59 mm	VPE height	43 mm
Classifications			
ETIM C O	5000007	ETIM 7.0	F0000007
ETIM 6.0 ETIM 8.0	EC002637 EC002637	ETIM 7.0 ECLASS 9.0	EC002637 27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 9.0 ECLASS 10.0	27-44-04-02
ECLASS 9.1 ECLASS 11.0	27-44-04-02	LOLAGO TU.U	∠1-44-U4-UZ
202.00 11.0	2, 10 02 01		
Important note			
IPC conformity	standards and norms and comp	eveloped, manufactured and delivered according ly with the assured properties in the data sheet r Class 2". Further claims on the products can be e	resp. fulfill decorative propert
Notes	Gold-plated contact surfaces	· · · · · · · · · · · · · · · · · · ·	valuated on request.
	Rated current related to rated	cross-section & min. No. of poles.	

- Diameter of solder eyelet D = 1.4+0.1mm
- Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months



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Technical data

Approvals

Approvals	(1)	

ROHS	Conform	
UL File Number Search	E60693	

Downloads

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	STEP
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN
	MB SMT EN
	FL DRIVES DE
	MB DEVICE MANUF. EN
	FL BUILDING SAFETY EN
	FL APPL LED LIGHTING EN
	FL INDUSTR.CONTROLS EN
	FL MACHINE SAFETY EN
	FL HEATING ELECTR EN
	FL APPL INVERTER EN
	FL_BASE_STATION_EN
	FL ELEVATOR EN
	FL POWER SUPPLY EN
	FL 72H SAMPLE SER EN
	PO OMNIMATE EN
	PO OMNIMATE EN



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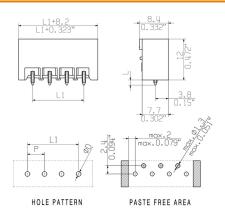
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Drawings

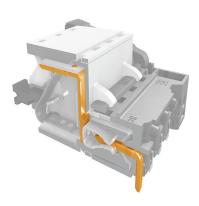
Product image



Dimensional drawing



Product benefits



Safe power transmission Proven properties



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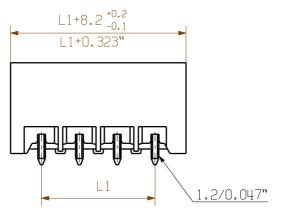
Klingenbergstraße 26 D-32758 Detmold Germany

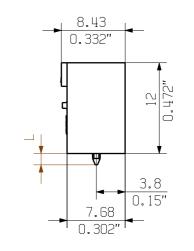
www.weidmueller.com

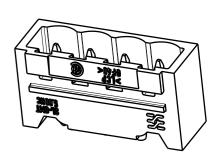
Drawings

Product benefits









115,00

110,00

105,00

100,00

95,00

90,00

85,00

80,00

75,00

70,00

65,00

60,00

55,00

50,00

45,00

40,00

35,00

30,00

9

8

4,528

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3,346

3,150

2,953

2,756

2,559

2,362 2,165

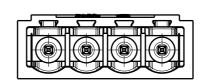
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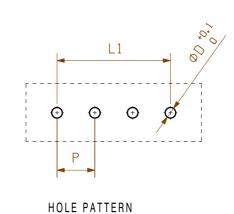
1,772 1,575

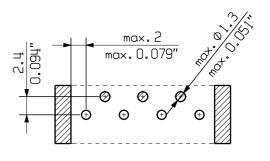
1,378

1,181

7279







PASTE FREE AREA

		•	00,00	.,
		6	25,00	0,984
STIFTLAENGE L	TOLERANZ	5	20,00	0,787
	0.0		15,00	0,591
1,5	-0.3	3	10,00	0,394
	0,3	2	5,00	0,197

STIFTLEISTE

PIN HEADER

D = 1.4/0.055" or 1.5/0.059"(REFLOW SOLDERING) RECOMMENDATION FOR AUTOMATIC ASSEMBLY (1.4 mm FOR n = 2...8 / 1.5 mm for n = 9...24)

Responsible

Checked

Approved

P = RASTER/PITCH

Scale: 2/1

Supersedes:

SHOWN: SL-SMT 5.00HC/04/180 G					5,2		-	0,3	n L1 [mm] [L1 [Inch]	
Dalle									C	Cat.no.:.		
ROMS		106340/4 30.07.18 HEI	RTEL_S 00	We	≥id	müll	er	7 2	C Drawing n	341	65	07
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Product file: SL-SMT 5.00

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27.08.2018 HERTEL S

For the mounting of PCBs, it should be noted that the rated data stated here relates only to the PCB components

alone.
The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.



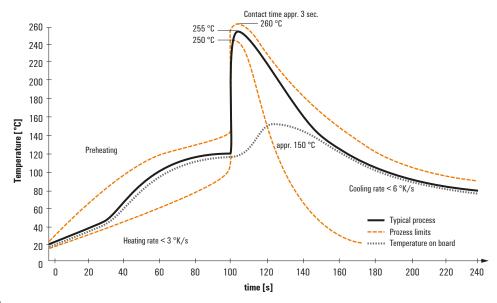
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

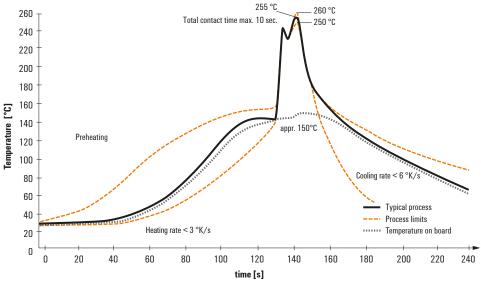
Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

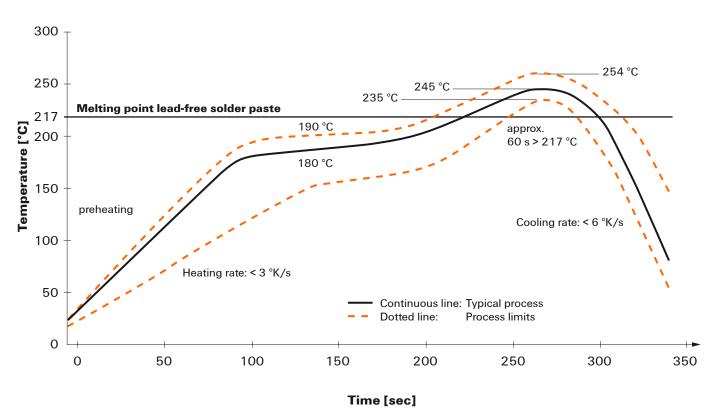


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.